



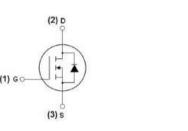
MJ N-Channel Enhancement Mode Power MOSFET

Description

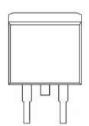
The MJ60H15D uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- $V_{DS} = 60V, I_{D} = 150A$ R_{DS(ON)} <4.5mΩ @ V_{GS}=10V
- ◆ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high EAS
- ◆ Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability







Application

◆ Power switching application

Uninterruptible power supply

Hard switched and High frequency circuits

Marking and pin assignment



TO-263-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ60H15D	MJ60H15D	TO-263-2L	4	-	-

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	60	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lp	150	А
Drain Current-Continuous(Tc =100°C)	ID(100°C)	105	А
Pulsed Drain Current	Ірм	600	А
Maximum Power Dissipation	PD	220	W
Derating factor		1.47	W/°C
Single pulse avalanche energy (Note 5)	Eas	1400	mJ
Operating Junction and Storage Temperature Range	TJ,TsTG	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	0.68	°C/W
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Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250μA	60	68	-	V
Zero Gate Voltage Drain Current	loss	Vps=60V,Vgs=0V	-	-	1	μA
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =250µA	2	3	4	V
Drain-Source On-State Resistance	Rds(on)	V _{GS} =10V, I _D =75A	-	3.6	4.5	mΩ
Forward Transconductance	grs	V _{DS} =50V,I _D =75A	180	-	-	S
Dynamic Characteristics (Note 4)	1					
Input Capacitance	Clss		-	4644	-	PF
Output Capacitance	Coss	V _{DS} =25V,V _{GS} =0V F=1.0MHz	-	460	-	PF
Reverse Transfer Capacitance	Crss		-	426	-	PF
Switching Characteristics (Note 4)	1					
Turn-on Delay Time	td(on)		-	26	-	nS
Turn-on Rise Time	tr	V _{DD} =30V,I _D =2A,R _L =15Ω	-	24	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =2.5Ω	-	91	-	nS
rn-Off Fall Time tr -		39	-	nS		
Total Gate Charge	Qg		-	113	-	nC
Gate-Source Charge	Qgs	V _{DS} =30V,I _D =30A V _{GS} =10V	-	20	-	nC
Gate-Drain Charge	Qgd		-	45	-	nC
Drain-Source Diode Characteristics						<u> </u>
Diode Forward Voltage (Note 3)	Vsp	V _{GS} =0V,I _S =40A	_	-	1.2	V
Diode Forward Current (Note 2)	ls		-	-	150	А
Reverse Recovery Time	trr	T1-25°C 1404	-	42	60	nS
Reverse Recovery Charge	TJ=25°C, IF=40A di/dt= 100A/µs ^(Note 3)		80	nC		
Forward Turn-On Time) S+I D			

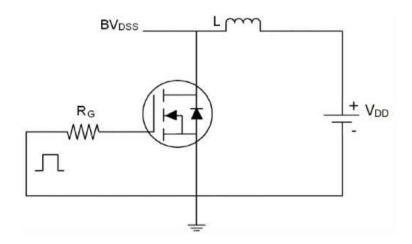
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, $t \le 10$ sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production
- § EAS condition: Tj=25°C,VDD=30V,VG=10V,L=0.5mH,Rg=25 Ω

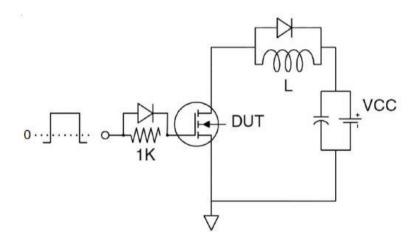




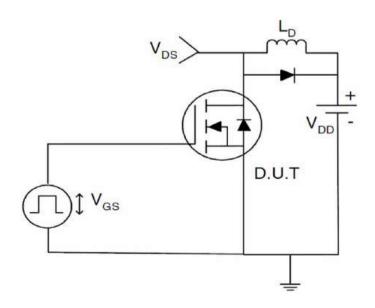
Test circuit



Eas test Circuit



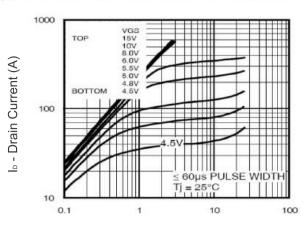
Gate charge test Circuit



Switch Time Test Circuit



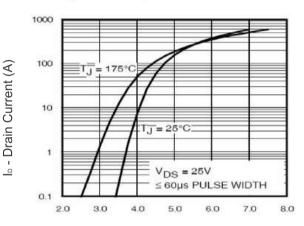
Typical Electrical and Thermal Characteristics (Curves)



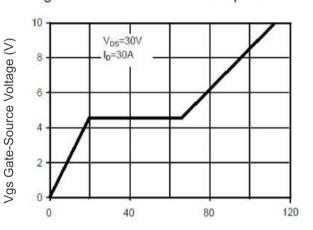
I_D = 75A V_{GS} = 10V Normalized On-Resistance GS 2.0 1.5 1.0 0.5 -60 -40 -20 20 40 60 80 100 120 140 160 180

Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics

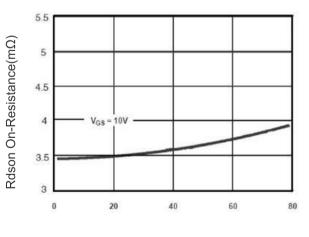


T_J -Junction Temperature(°C) Figure 4 Rdson-Junction Temperature

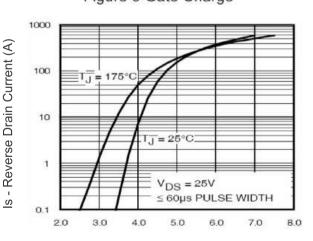


Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics



Qg Gate Charge (nC) Figure 5 Gate Charge



I_D - Drain Current (A)

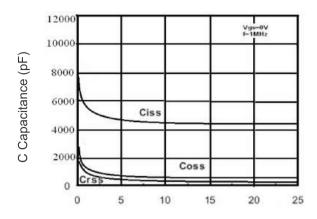
Figure 3 Rdson- Drain Current

Vsd Source-Drain Voltage (V) Figure 6 Source- Drain Diode Forward

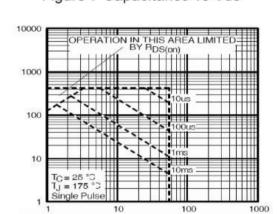


lo - Drain Current (A)

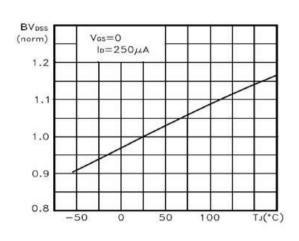




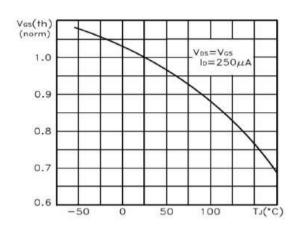
Vds Drain-Source Voltage (V) Figure 7 Capacitance vs Vds



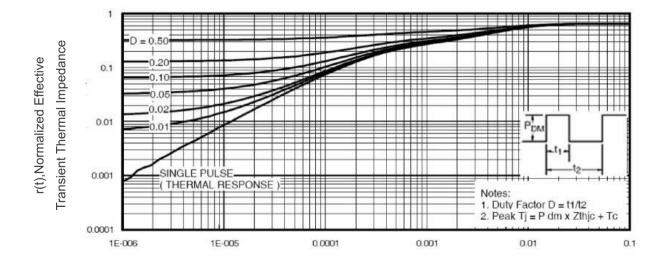
Vds Drain-Source Voltage (V) Figure 8 Safe Operation Area



T_J -Junction Temperature(°C) Figure 9 BVpss vs Junction Temperature



T_J -Junction Temperature(°C) Figure 10 V_{GS(th)} vs Junction Temperature

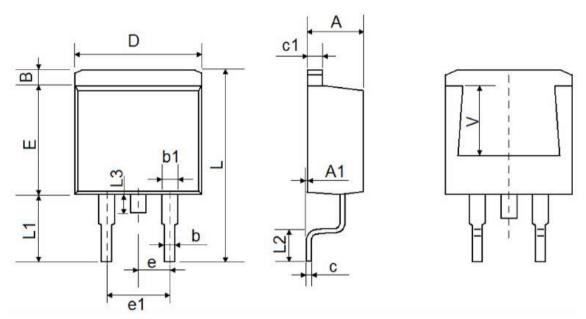


Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance





TO-263-2L Package Information



Complete	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.170	1.370	0.046	0.054	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
c	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
E	8.500	8.900	0.335	0.350	
е	2.540	TYP.	0.100	TYP.	
e1	4.980	5.180	0.196	0.204	
L	15.050	15.450	0.593	0.608	
L1	5.080	5.480	0.200	0.216	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
V	5.600	5.600 REF 0.220 REF		REF	





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